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SEMICONDUCTOR®

FDT86113LZ

N-Channel PowerTrench[®] MOSFET 100 V, 3.3 A, 100 m Ω

Features

- Max r_{DS(on)} = 100 mΩ at V_{GS} = 10 V, I_D = 3.3 A
- Max r_{DS(on)} = 145 mΩ at V_{GS} = 4.5 V, I_D = 2.7 A
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability in a widely used surface mount package
- HBM ESD protection level > 3 KV typical (Note 4)
- 100% UIL tested
- RoHS Compliant



General Description

This N-Channel logic Level MOSFETs are produced using Fairchild Semiconductor's advanced Power Trench[®] process that has been special tailored to minimize the on-state resistance and yet maintain superior switching performance. G-S zener has been added to enhance ESD voltage level.

Application

DC - DC Switch





MOSFET Maximum Ratings T_C = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous			3.3	^	
D	-Pulsed			12	А	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	9	mJ	
P _D	Power Dissipation T	_А = 25 °С	(Note 1a)	2.2	W	
	Power Dissipation T	_А = 25 °С	(Note 1b)	1.0		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	12	°C ///
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a) 55	C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
86113LZ	FDT86113LZ	SOT-223	13 "	12 mm	2500 units

March 2011

DT86113LZ
N-Channel F
⁹ owerTrench
® MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	100			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		71		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V			±10	μA
On Chara	acteristics (Note 2)					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	1.0	1.7	2.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-5		mV/°C
		V _{GS} = 10 V, I _D = 3.3 A		75	100	
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 4.5 V, I _D = 2.7 A		95	145	
		V _{GS} = 10 V, I _D = 3.3 A, T _J = 125 °C		140	189	189
9fs	Forward Transconductance	V _{DS} = 10 V, I _D = 3.3 A		8		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			234	315	pF
C _{oss}	Output Capacitance	$V_{DS} = 50 V, V_{GS} = 0 V,$		46	65	pF
C _{rss}	Reverse Transfer Capacitance			3.1	5	pF
Switchin	g Characteristics					
t _{d(on)}	Turn-On Delay Time			3.8	10	ns
t _r	Rise Time	V _{DD} = 50 V, I _D = 3.3 A,		1.3	10	ns
t _{d(off)}	Turn-Off Delay Time	V _{GS} = 10 V, R _{GEN} = 6 Ω		10	20	ns
t _f	Fall Time			1.5	10	ns
Q _q	Total Gate Charge	V _{GS} = 0 V to 10 V		4.1	6.8	nC
Q _g	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V$ $V_{DD} = 50 V$,		2.3	3.9	nC
Q _{gs}	Gate to Source Gate Charge	I _D = 3.3 A		0.68		nC
					1	-

V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 3.3 A$ (Note 2	2)	0.86	1.3	V
		$V_{GS} = 0 V, I_S = 1 A$ (Note 2	2)	0.77	1.2	
t _{rr}	Reverse Recovery Time	L = 3.3 A di/dt = 100 A/us		31	49	ns
Q _{rr}	Reverse Recovery Charge	$F = 3.3 \text{ A}, \text{ and } = 100 \text{ A/} \mu \text{s}$		21	34	nC

Notes: 1. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta JA}$ is determined by the user's board design.



a) 55 °C/W when mounted on a 1 in² pad of 2 oz copper



b) 118 °C/W when mounted on a minimum pad of 2 oz copper

2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

3. Starting T_J = 25°C, L = 0.3 mH, I_{AS} = 8 A, V_{DD} = 90 V, V_{GS} = 10 V.

4. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.











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